Philips Semiconductors

Three quadrant triacs high commutation

GENERAL DESCRIPTION

Glass passivated high commutation

triacs in a full pack, plastic envelope intended for use in circuits where high static and dynamic dV/dt and high dl/dt can occur. These devices will commutate the full rated rms current

at the maximum rated junction temperature, without the aid of a

QUICK REFERENCE DATA

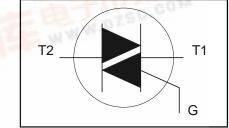
SYMBOL	PARAMETER	MAX.	MAX.	MAX.	UNIT
V _{DRM}	Repetitive peak off-state voltages	500B 500	600B 600	800B 800	V
I _{T(RMS)} I _{TSM}	RMS on-state current Non-repetitive peak on-state current	12 95	12 95	12 95	A A

PINNING - SOT186A

snubber.

PIN CONFIGURATION

SYMBOL



may

PIN	DESCRIPTION	case	- 19-1/
1	main terminal 1		T2
2	main terminal 2		
3	gate	TO COM	
case	isolated		

LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	-	MAX.		UNIT
V _{drm}	Repetitive peak off-state voltages		1	-500 500 ¹	-600 600 ¹	-800 800	V
I _{T(RMS)}	RMS on-state current	full sine wave; T _{hs} ≤ 56 °C	9		12		А
I _{TSM}	Non-repetitive peak on-state current	full sine wave; $T_j = 25 \degree C$ prior to surge			05		
61/20		t = 20 ms t = 16.7 ms	-		95 105		A
l ² t	I ² t for fusing	t = 10 ms	-		45		A A ² s
dl _⊤ /dt	Repetitive rate of rise of on-state current after triggering	$I_{TM} = 20 \text{ A}; I_G = 0.2 \text{ A}; dI_G/dt = 0.2 \text{ A}/\mu s$			100		A/μs
I _{GM}	Peak gate current				2		А
V _{GM}	Peak gate voltage				2 5 5		V
I P _{GM}	Peak gate power	LITER MAL					W
P _{G(AV)}	Average gate power	over any 20 ms	-		0.5		W
T _{stg} T _j	Storage temperature Operating junction temperature	250.0	-40 -		150 125		Û Û

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-	Altouy	not recommended he on-state. The rat	UII-SIALE VUILAGES	up to 600 v ma	iy be applied without	u uamaye,	but the that i
1	Courses to t	a on ototo. The rot	a of ride of ourrant.	hould not ove	and 1E Alun	-	
- 4	Switch to t	ne on-state. The fat	e of fise of current :	should not exc	eed to A/µs.		
\sum	DOTOZSC CC						



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Product specification

BTA212X series **B**

BTA212X series B

ISOLATION LIMITING VALUE & CHARACTERISTIC

 $T_{hs} = 25$ °C unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V _{isol}	R.M.S. isolation voltage from all three terminals to external heatsink	f = 50-60 Hz; sinusoidal waveform; R.H. \leq 65% ; clean and dustfree	-		2500	V
C _{isol}	Capacitance from T2 to external heatsink	f = 1 MHz	-	10	-	pF

THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
R _{th j-hs} R _{th j-a}	Thermal resistance junction to heatsink Thermal resistance junction to ambient	full or half cycle with heatsink compound without heatsink compound in free air	- -	- - 55	4.0 5.5 -	K/W K/W K/W

STATIC CHARACTERISTICS

$T_i = 25$ °C unless otherwise stated

SYMBOL	PARAMETER	CONDITIONS		MIN.	TYP.	MAX.	UNIT
I _{GT}	Gate trigger current ²	$V_{\rm D} = 12 \text{ V}; \text{ I}_{\rm T} = 0.1 \text{ A}$					
01			[2+ G+	2 2	18	50	mA
		Т Т	[2+ G-		21	50	mA
		Т Т	[2- G-	2	34	50	mA
IL .	Latching current	$V_{\rm D} = 12 \text{ V}; I_{\rm GT} = 0.1 \text{ A}$					
_	-	Т Т	[2+ G+	-	31	60	mA
		Т Т	[2+ G-	-	34	90	mA
		-	[2- G-	-	30	60	mA
I _H	Holding current	$V_{\rm D} = 12 \text{ V}; I_{\rm GT} = 0.1 \text{ A}$		-	31	60	mA
ι _н V _T	On-state voltage	$I_{T} = 17 \text{ A}$		-	1.3	1.6	V
V _{GT}	Gate trigger voltage	$V_{\rm D} = 12 \text{ V}; I_{\rm T} = 0.1 \text{ A}$		-	0.7	1.5	V
		$V_{\rm D} = 400 \text{ V}; I_{\rm T} = 0.1 \text{ A}; T_{\rm i} = 125 ^{\circ}\text{C}$	C	0.25	0.4	-	V
I _D	Off-state leakage current	$V_D = V_{DRM(max)}; T_j = 125 °C$		-	0.1	0.5	mA

DYNAMIC CHARACTERISTICS

 $T_i = 25$ °C unless otherwise stated

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
dV _D /dt	Critical rate of rise of	$V_{DM} = 67\% V_{DRM(max)}; T_j = 125 °C;$	1000	4000	-	V/µs
dl _{com} /dt	off-state voltage Critical rate of change of commutating current	exponential waveform; gate open circuit $V_{DM} = 400 \text{ V}; \text{ T}_{j} = 125 ^{\circ}\text{C}; \text{ I}_{T(RMS)} = 12 \text{ A};$ without snubber; gate open circuit	-	24	-	A/ms
t _{gt}	Gate controlled turn-on time	$I_{TM} = 12 \text{ A}; V_D = V_{DRM(max)}; I_G = 0.1 \text{ A};$ $dI_G/dt = 5 \text{ A}/\mu\text{s}$	-	2	-	μs

² Device does not trigger in the T2-, G+ quadrant.

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Fig.6. Normalised gate trigger voltage

 $V_{GT}(T_i)/V_{GT}(25^{\circ}C)$, versus junction temperature T_i .

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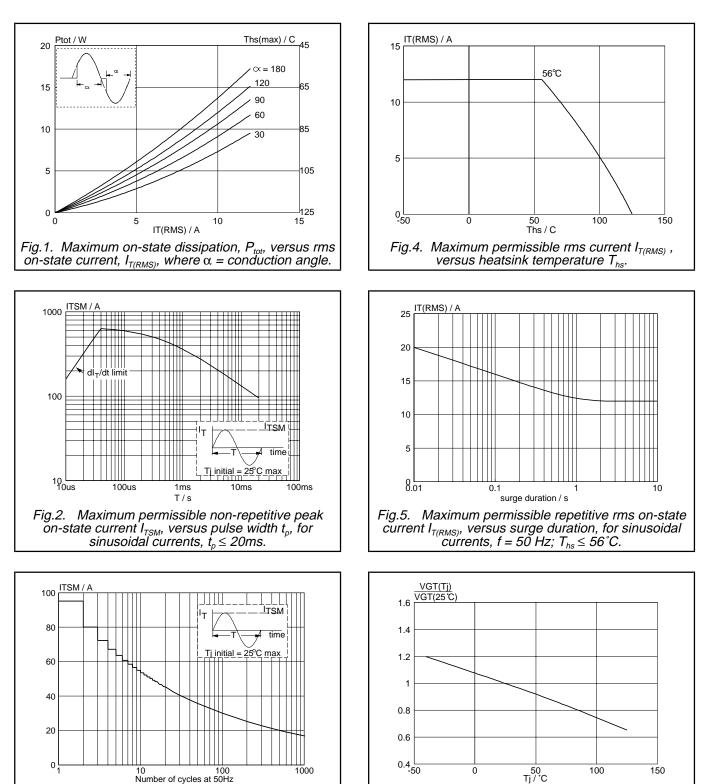
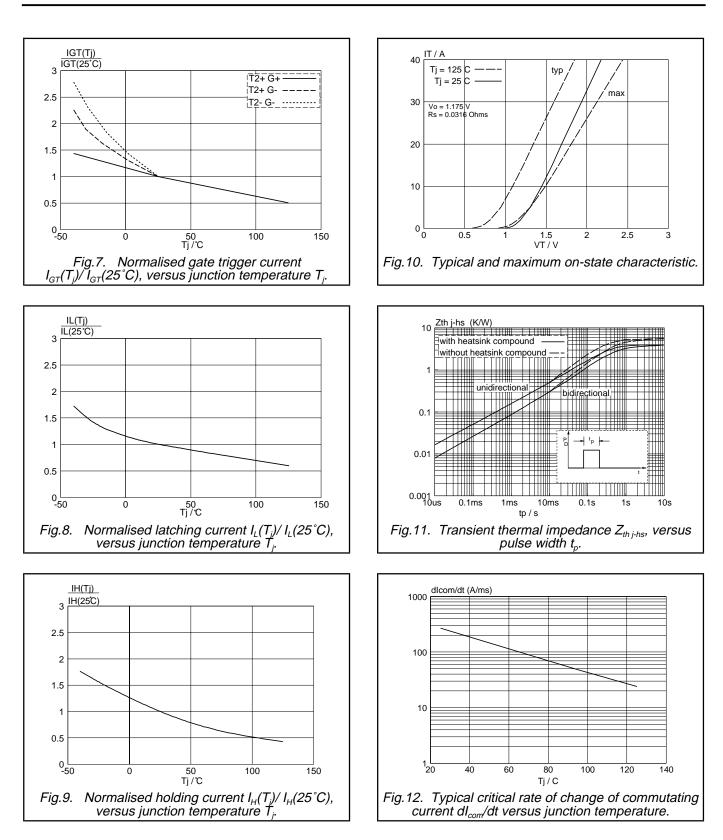


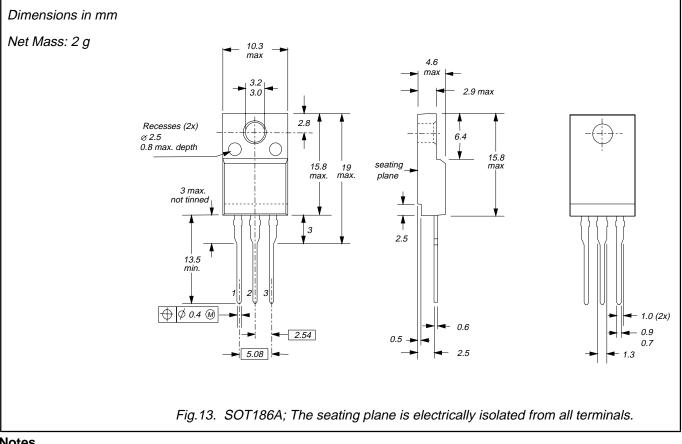
Fig.3. Maximum permissible non-repetitive peak on-state current I_{TSM} , versus number of cycles, for sinusoidal currents, f = 50 Hz.

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MECHANICAL DATA



Notes

Refer to mounting instructions for F-pack envelopes.
Epoxy meets UL94 V0 at 1/8".

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DEFINITIONS

Data sheet status					
Objective specification	This data sheet contains target or goal specifications for product development.				
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.				
Product specification	This data sheet contains final product specifications.				

Limiting values

Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

Application information

Where application information is given, it is advisory and does not form part of the specification.

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